

IEEE Journal of Microwaves

“Expanding Science, Technology & Connectivity Around the Globe”

Announcing a very Special Issue Celebrating the 70th Anniversary of the MTT Society

Initial Manuscript Submission Deadline: Monday, October 3rd, 2022



The Microwave Theory and Technology Society is celebrating 70 years of service to the microwave engineering and science communities throughout 2022. This special issue of the **IEEE Journal of Microwaves** will document some of the many topic areas and significant contributions that have been made over the years.

General interest review articles, historic accounts, and new contributions highlighting developments that have come out of our rich historic narrative are all welcome.

If you have a particular idea or topic you would like to contribute please contact our special issue guest editor: **Professor Ke Wu**, Ecole Polytechnique, Montreal, Canada (ke.wu@polymtl.ca) or **Peter Siegel**, JMW Editor-in-Chief (phs@caltech.edu).

The deadline for submission of initial manuscripts is Monday, **October 3rd, 2022**. Final upload of accepted paper proofs is **December 1, 2022**. All production ready manuscripts will be posted on IEEE Xplore Early Access and will appear in final paginated sequence in the Special Issue – scheduled for final release in January 2023.

Manuscripts should be formatted and submitted using the instructions, templates and links that can be found at: <https://mtt.org/publications/journal-of-microwaves/manuscript-submission/>. Contributed papers should be targeted at ten pages but review and special invited papers can be longer. All submissions will be reviewed in accordance with the normal procedures of the Journal. Please tag uploaded papers as “Special Issue” at Manuscript Central.

Additional multidisciplinary topics and regular research articles will also be considered. Prospective authors should contact our Guest Editor or Editor-in-Chief if they wish to suggest or discuss specific contributions.

We hope you will consider contributing to this Special Issue of *IEEE Journal of Microwaves* and continue to support the journal through your regular research submissions.

